

**OMNIMATE-data - RJ45-uttag
RJ45C6 R1V 3.2N4N TY****Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 16

D-32758 Detmold

Germany

Fon: +49 5231 14-0

Fax: +49 5231 14-292083

www.weidmueller.com



Produktsortimentet omfattar följande designtyper:

- 90°, liggande (horisontell) och 180°, stående (vertikal)
- spärr upp/spärr ned
- Lödningsprocess THT, THR eller SMD
- Brett utbud av olika designtyper, även med inbyggda lysdioder och skärmade kontaktflikar
- Effektkategori kat. 3 till kat. 6
- Förpackad antingen på bricka (TY) eller antistatiskt på tape-on-reel (RL)

Egenskaper och fördelar:

- Utökat temperaturområde på -40 °C till +85 °C för maximal prestandakapacitet
- Förstärkt guldager (30 µm) för förbättrat korrosionsskydd
- Minst 3 mm fritt utrymme garanterar ett perfekt lödresultat

Allmänna beställningsdata

Typ	RJ45C6 R1V 3.2N4N TY
Art.nr.	2634590000
Artikelbeteckning	Kretskortsstickanslutning, RJ45-uttag, THT/THR lödanslutning, 180°, Antal poler: 8
GTIN (EAN)	4050118651270
Frp	160 Stück

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Tekniska data**Mått och vikter**

Nettovikt	7,475 g
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Environmental Product Compliance

REACH SVHC	Lead 7439-92-1
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Systemparametrar

Anslutningsvinkel	180°	Antal poler	8
Montering på kretskortet	THT/THR lödanslutning	Produktfamilj	OMNIMATE-data - RJ45-uttag
Skyddsklass	IP20	Skärmarea	förnicklad
Stickcykler	750		

Packaging

VPE-längd	0,315 m	VPE-bredd	0,195 m
VPE-höjd	0,065 m		

Klassificeringar

ETIM 6.0	EC002637	eClass 6.2	27-26-07-04
eClass 9.0	27-44-04-02	eClass 9.1	27-44-04-02

Godkännanden

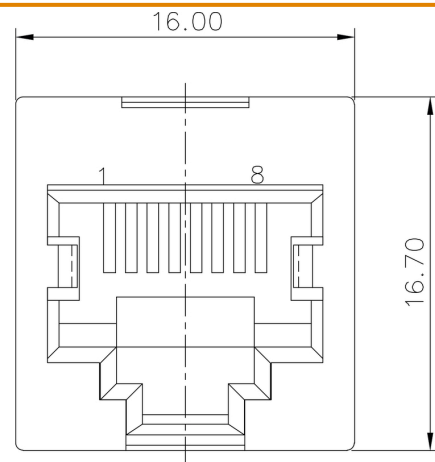
ROHS	Uppfyllelse
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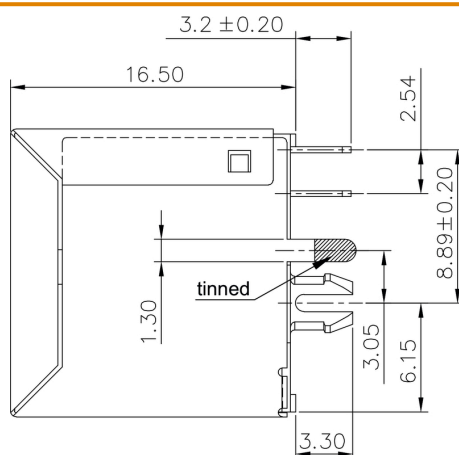
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Ritningar

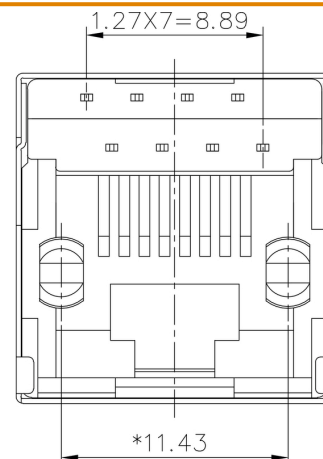
Profilritning



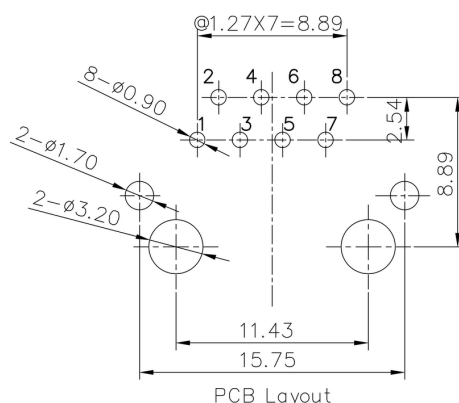
Profilritning



Profilritning



Kretskortsdesign

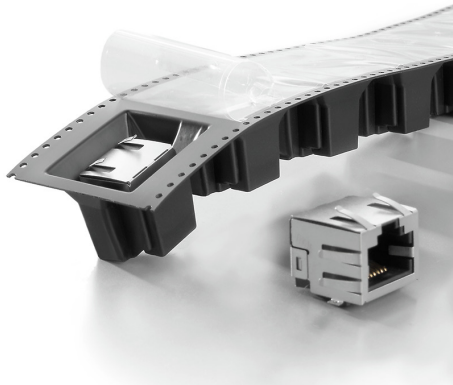


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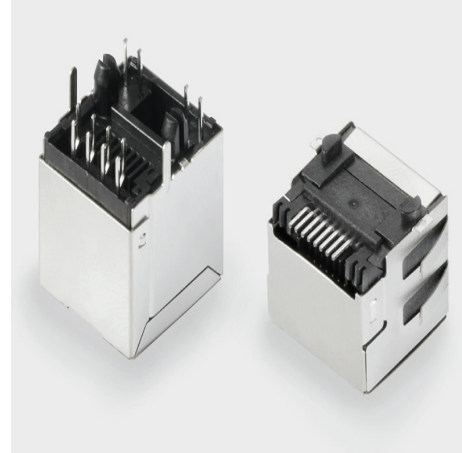
Produktfördel



Process-optimised packaging
Tape-on-reel or tray

Produktfördel

Produktfördel



Trouble-free assembly
Short, chamfered solder pins



Suitable for all soldering processes
SMT, THT or THR

Skapandedatum den 9 juli 2019 17:07:36 CEST

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Ritningar

Legend

RJ45	G1	R	1	U	3.2	E	4	GY/GY	TY	RJ45G1 R1U 3.2E4GY/GY TY
										Packaging
										TY
										Tray in box (manual assembly)
										Tape on Reel (automated assembly)
										LED
										Y/G
										Yellow/Green
										G/Y
										Green/Yellow (standard)
										GY/GY
										Green-Yellow/Green-Yellow
										O/G
										Orange/Green
										R/O
										Red/Orange
										... (further combinations possible)
										N
										without LED
										Contact surface thickness
										4
										1 = 3µ", 2 = 6µ", 3 = 15µ", 4 = 30µ", 5 = 50µ"
										EMI tabs (ground fingers)
										E
										E = with EMI tabs
										N
										N = without EMI tabs
										Solder Pin length
										3.2
										3.2 mm
										1.6
										1.6 mm
										D
										SMD
										Direction, latch style
										U
										Horizontal (90°, side entry), latch up
										D
										Horizontal (90°, side entry), latch down
										V
										Vertical (180°, top entry)
										Y
										Diagonal (45°), latch up
										Number of Ports
										1
										1 Port
										12; 14; ...
										multi ports side by side, Multiport
										21; 41; ...
										multi ports about each other, Multilevel
										Assembly on PCB
										R
										Through Hole Reflow - THR
										Soldering process: Wave or Reflow soldering
										S
										Surface Mount Technology - SMT
										Soldering process: Reflow soldering
										T
										Through Hole Technology - THT
										Soldering process: Wave
										Performance Category
										C5
										Category 5
										C6
										Category 6
										C6A
										Category 6A
										C5e
										Category 5e
										M
										10/100 Mbit
										G1
										10/100/1000 Mbit
										G10
										10 Gbit
										U
										Unshielded
										MP
										10/100 Mbit with POE
										MP+
										10/100 Mbit with POE+

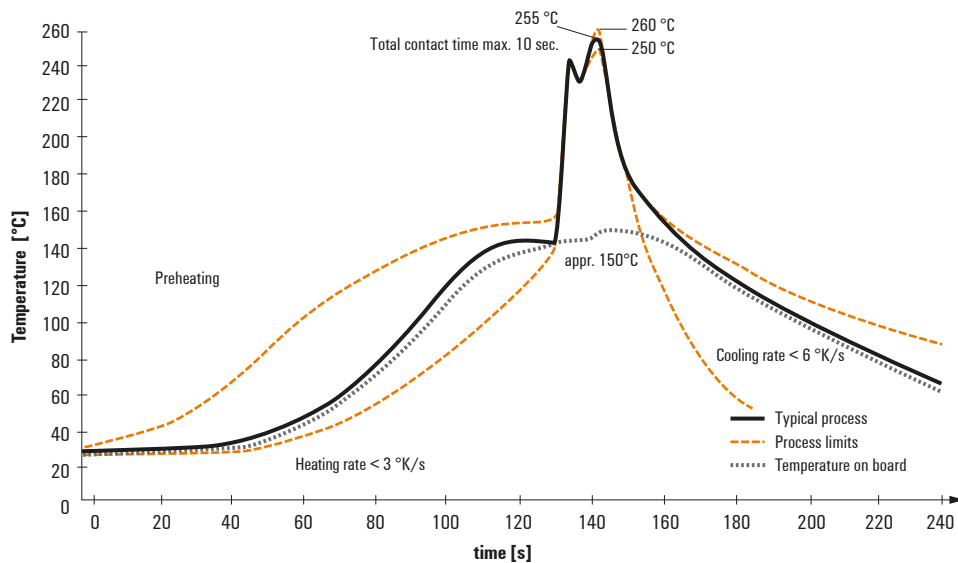
Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Klingenbergstraße 16

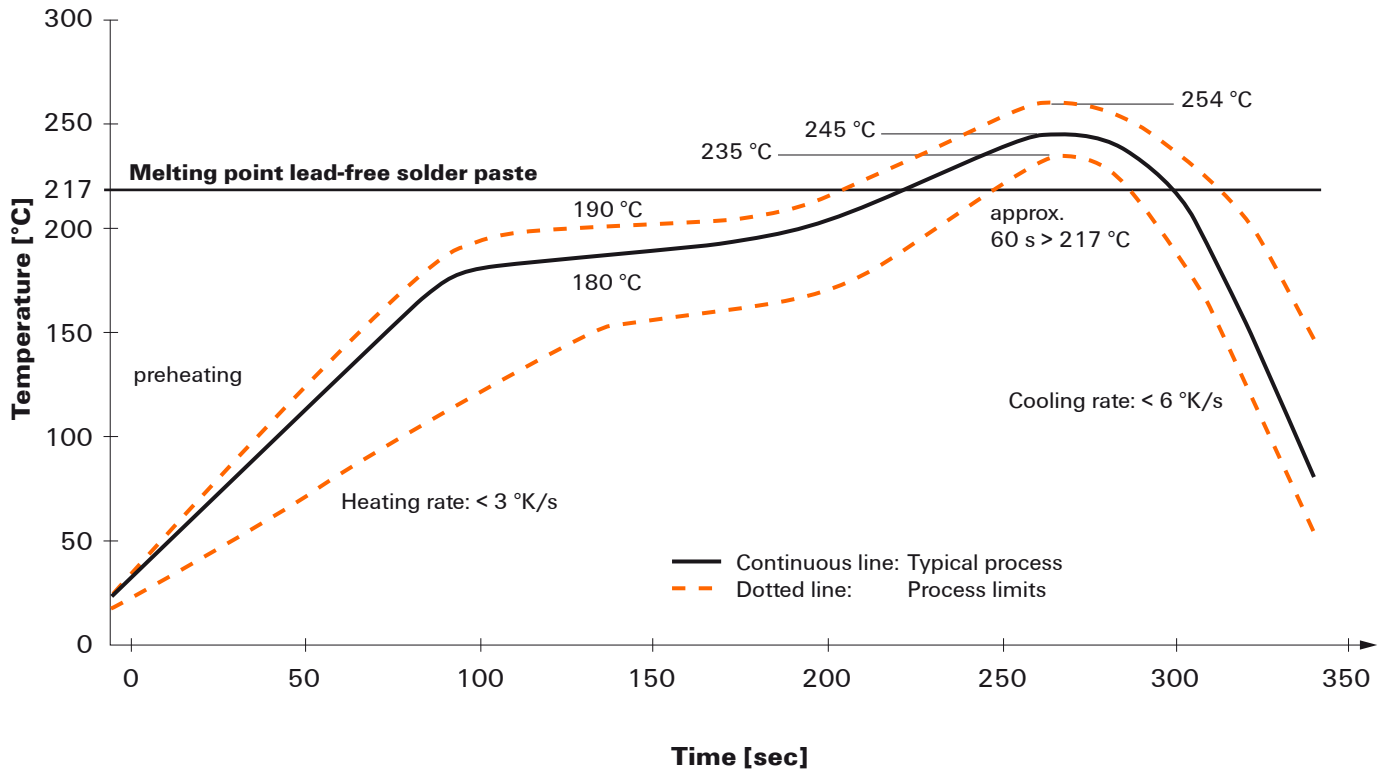
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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.